Surface Mount Schottky Power Rectifier

POWERMITE[®] Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

Features:

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Low VF Provides Higher Efficiency and Extends Battery Life
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

Mechanical Characteristics:

- Powermite is JEDEC Registered as DO-216AA
- Case: Molded Epoxy
- Epoxy Meets UL94V-0 at 1/8"
- Weight: 62 mg (approximately)
- Device Marking: BCJ
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

MAXIMUM RATINGS

Please See the Table on the Following Page



ON Semiconductor[™]

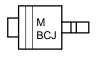
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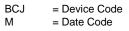
SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 40 VOLTS



POWERMITE CASE 457 PLASTIC

MARKING DIAGRAM





ORDERING INFORMATION

Device	Device Package Shipping	
MBRM140T1	POWERMITE	3000/Tape & Reel
MBRM140T3	POWERMITE	12,000/Tape & Reel

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
Average Rectified Forward Current (At Rated V_R , $T_C = 110^{\circ}C$)	IO	1.0	А
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 100 kHz, T _C = 110°C)	IFRM	2.0	A
Non–Repetitive Peak Surge Current (Non–Repetitive peak surge current, halfwave, single phase, 60 Hz)	IFSM	50	A
Storage Temperature	T _{stg}	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs

THERMAL CHARACTERISTICS

Thermal Resistance – Junction-to-Lead (Anode) (Note 1)	R _{til}	35	°C/W
Thermal Resistance – Junction–to–Tab (Cathode) (Note 1)	R _{titab}	23	
Thermal Resistance – Junction–to–Ambient (Note 1)	R _{tja}	277	

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 9 & 10.

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2), See Figure 2	٧F	TJ = 25°C	T _J = 85°C	V
$(I_F = 0.1 A)$ $(I_F = 1.0 A)$ $(I_F = 3.0 A)$		0.36 0.55 0.85	0.30 0.515 0.88	
Maximum Instantaneous Reverse Current (Note 2), See Figure 4	IR	Tj = 25°C	TJ = 85°C	mA
(V _R = 40 V) (V _R = 20 V)		0.5 0.15	25 18	

2. Pulse Test: Pulse Width \leq 250 µs, Duty Cycle \leq 2%.

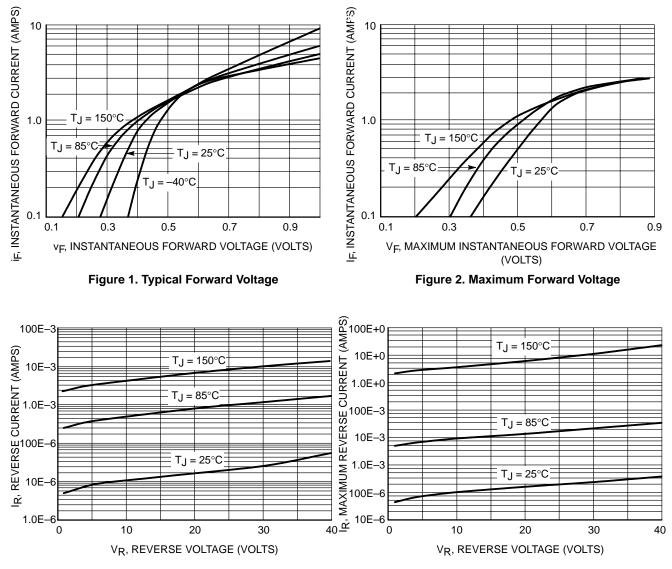
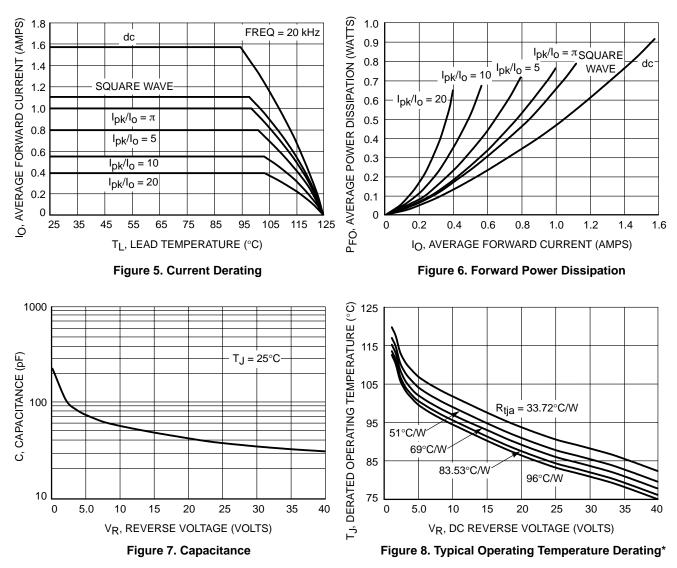


Figure 3. Typical Reverse Current

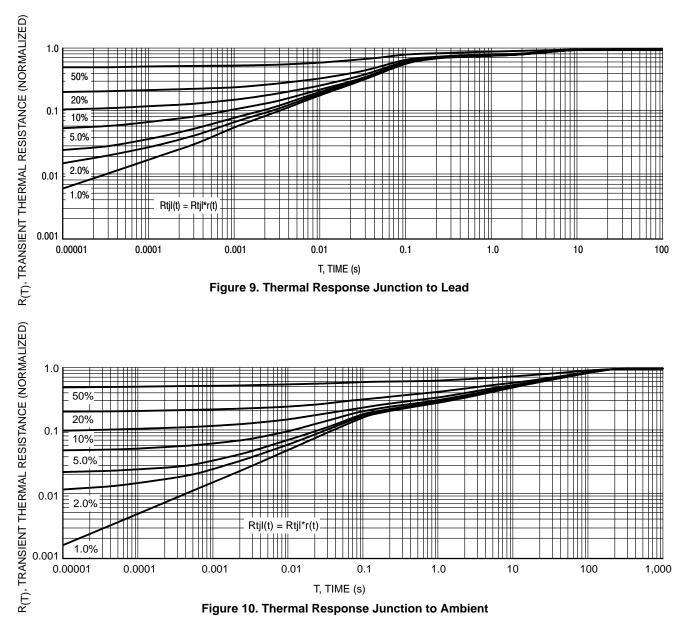
Figure 4. Maximum Reverse Current

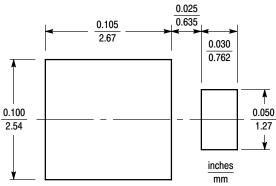


* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T_J therefore must include forward and reverse power effects. The allowable operating T_J may be calculated from the equation: $T_J = T_{Jmax} - r(t)(Pf + Pr)$ where

- r(t) = thermal impedance under given conditions,
- Pf = forward power dissipation, and
- Pr = reverse power dissipation

This graph displays the derated allowable T_J due to reverse bias under DC conditions only and is calculated as $T_J = T_{Jmax} - r(t)Pr$, where r(t) = Rthja. For other power applications further calculations must be performed.



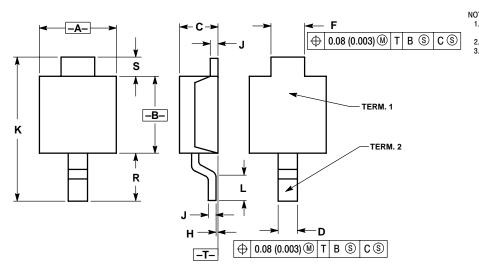


Minimum Recommended Footprint

PACKAGE DIMENSIONS

POWERMITE

PLASTIC PACKAGE CASE 457-04 ISSUE D



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS. SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.75	2.05	0.069	0.081
В	1.75	2.18	0.069	0.086
С	0.85	1.15	0.033	0.045
D	0.40	0.69	0.016	0.027
F	0.70	1.00	0.028	0.039
Н	-0.05	+0.10	-0.002	+0.004
J	0.10	0.25	0.004	0.010
K	3.60	3.90	0.142	0.154
L	0.50	0.80	0.020	0.031
R	1.20	1.50	0.047	0.059
S	0.50 REF		0.019	REF

<u>Notes</u>

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